

Part Number : 440672001

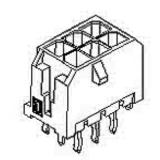
**Product Description :** Micro-Fit 3.0 Wire-to-Board Header, Dual Row, Vertical for up to 3.56mm Thick

PCB, 20 Circuits, Tin (Sn) Plating

Series Number: 44067

**Status**: Active

**Product Category :** PCB Headers and Receptacles



### **Documents & Resources**

### **Drawings**

440672001 sd.pdf

PK-70873-0314-001.pdf

### **3D Models and Design Files**

STEP AP242

**SOLIDWORKS** 

Creo

Symbol and Footprint (Multi-Format)

SYM-44067-200X-001.zip

#### **Specifications**

430450001-PS-KO-000.pdf

430450001-PS-SP-000.pdf

PS-43045-001.pdf

430450005-TS-000.pdf

430450007-TS-000.pdf

TS-43045-001-001.pdf

TS-43045-002-001.pdf

TS-46235-001-001.pdf

## **Product Environment Compliance**

### Compliance

GADSL/IMDS	Not Relevant
China RoHS	•

	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

### **Compliance Statements**

- EU RoHS
- REACH SVHC
- Low-Halogen

## **Industry Documents**

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

## **Substances of Interest**

• PFAS

### **EU RoHS Certificate of Compliance**

## Additional Product Compliance Information

### **Part Details**

#### **General**

Status	Active
Category	PCB Headers and Receptacles
Series	44067
Description	Micro-Fit 3.0 Wire-to-Board Header, Dual Row, Vertical for up to 3.56mm Thick PCB, 20 Circuits, Tin (Sn) Plating
Application	Power, Wire-to-Board
Comments	High Temperature, Polarization Key to PCB
Component Type	PCB Header
Product Name	Micro-Fit 3.0
UPC	800756476407

# Agency

UL	E29179
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# Electrical

Current - Maximum per Contact	8.5A
Voltage - Maximum	250V

# Physical

Breakaway	No
Circuits (Loaded)	20
Circuits (maximum)	20
Color - Resin	Black
Durability (mating cycles max)	30
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	2.757/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	3.60mm
PC Tail Length	4.01mm
Pitch - Mating Interface	3.00mm
Pitch - Termination Interface	3.00mm
Plating min - Mating	2.540µm
Plating min - Termination	2.540µm
Polarized to PCB	Yes

Shrouded	Fully
Stackable	No
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole - Kinked Pin

## **Solder Process Data**

Max-Duration	30
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	3
Max-Temp	260

# Mates With / Use With

# Mates with Part(s)

Description	Part Number
Micro-Fit 3.0 Dual Row Receptacle Housings	<u>43025</u>

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